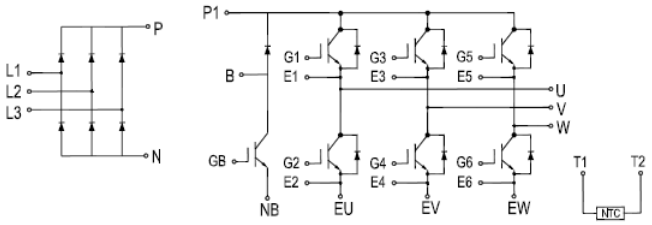
GTS25PI120C7H

IGBT Module

Preliminary Data

Features：



- Trench IGBT Technology
- Short Circuit Rated>10μs
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested（2×Ic）
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement

Applications：

- Industrial Inverters
- Servo Applications

IGBT, Inverter

Maximum Rated Values (T_C=25℃unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		±20	V
I_C	Continuous Collector Current	T_C = 100℃	25	A
		T_C = 25℃	50	A
$I_{CM(1)}$	Peak Collector Current Repetitive	T_J = 150℃	50	A
t_{SC}	Short Circuit Withstand Time		>10	μs
P_D	Maximum Power Dissipation per IGBT	T_C = 25℃ T_{Jmax}=175℃	250	W

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Electrical Characteristics of IGBT (T_C=25℃unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions		Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C = 1 mA, V_{CE} = V_{GE}		5.0	5.9	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C =25A, V_{GE} = 15V	T_J = 25℃		2.20	2.50	V
			T_J = 125℃		2.40		V
I_{CES}	Collector-Emitter Leakage Current	V_{GE} = 0V, V_{CE} = V_{CES}, T_J = 25℃				1	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE} = ±20V, V_{CE} = 0V, T_J = 25℃				200	nA
C_{ies}	Input Capacitance	V_{CE} = 25V, V_{GE} = 0V , f =1MHz			1.72		nF
C_{oes}	Output Capacitance				0.43		nF
Cres	Reverse Transfer Capacitance				0.08		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	V_{CC} = 600V,I_C = 25A, R_G = 20Ω,V_{GE} = ±15V, Inductive Load	T_J = 25℃		109		ns
			T_J = 125℃		115		
t_r	Rise Time		T_J = 25℃		37		ns
			T_J = 125℃		42		
td(off)	Turn-off Delay Time		T_J = 25℃		175		ns
			T_J = 125℃		190		
t_f	Fall Time		T_J = 25℃		221		ns
			T_J = 125℃		379		
E_{on}	Turn-on Switching Loss		T_J = 25℃		1.86		mJ
			T_J = 125℃		2.45		
E_{off}	Turn-off Switching Loss		T_J = 25℃		0.90		mJ
			T_J = 125℃		1.68		
Q_g	Total Gate Charge		T_J = 25℃		430		nC
RBSOA	Reverse Bias Safe Operation Area	I_C=50A,V_{CC}=960V,Vp=1200V, Rg = 20Ω, V_{GE}=+15V to 0V, T_J =175°C		Trapezoid			
SCSOA	Short Circuit Safe Operation Area	V_{CC} = 600V, V_{GE} = 15V, T_J = 150℃		10			μs
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case				0.499		℃/W

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Diode, Inverter

Maximum Rated Values (T_C=25℃unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	25	A
I_{FM}	Repetitive Peak Forward Current	50	A

Electrical Characteristics of FWD (T_C=25℃unless otherwise specified)

Symbol	Description	Conditions		Min	Typ	Max	Unit
V_{FM}	Forward Voltage	I_F = 25A	T_J = 25℃		2.20		V
			T_J = 125℃		2.35		
t_{rr}	Reverse Recovery Time	I_F=25A, di/dt =658A/μs, V_{rr} = 600V, V_{GE} = -15V	T_J = 25℃		148		
			T_J = 125℃		282		
I_{rr}	Peak Reverse Recovery Current		T_J = 25℃		14.1		A
			T_J = 125℃		19.1		
Q_{rr}	Reverse Recovery Charge		T_J = 25℃		1.34		μC
			T_J = 125℃		2.72		
E_{rec}	Reverse Recovery Energy		T_J = 25℃		0.21		mJ
			T_J = 125℃		1.03		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case				0.730		℃/W

IGBT, Brake-Chopper

Maximum Rated Values (T_C=25℃unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		±20	V
I_C	Continuous Collector Current	T_C = 100℃	25	A
		T_C = 25℃	50	A
I_{CM}	Peak Collector Current Repetitive	T_J = 150℃	50	A
t_{SC}	Short Circuit Withstand Time		>10	μs
P_D	Maximum Power Dissipation (IGBT)	T_C = 25℃ T_{Jmax}=150℃	250	W

Electrical Characteristics of IGBT (T_C=25℃unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions		Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C = 1 mA, V_{CE} = V_{GE}		5.0	5.9	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C =25A, V_{GE} = 15V	T_J = 25℃		2.20	2.50	V
			T_J = 125℃		2.40		V
I_{CES}	Collector-Emitter Leakage Current	V_{GE} = 0V, V_{CE} = V_{CES}, T_J = 25℃				1	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE} = ±20V, V_{CE} = 0V, T_J = 25℃				200	nA
C_{ies}	Input Capacitance	V_{CE} = 25V, V_{GE} = 0V , f ＝1MHz			1.72		nF
C_{Oes}	Output Capacitance				0.43		nF
C_{res}	Reverse Transfer Capacitance				0.08		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	V_{CC} = 600V,I_C = 25A, R_G = 20Ω,V_{GE} = ±15V, Inductive Load	T_J = 25℃		109		ns
			T_J = 125℃		115		
t_r	Rise Time		T_J = 25℃		37		ns
			T_J = 125℃		42		
td(off)	Turn-off Delay Time		T_J = 25℃		175		ns
			T_J = 125℃		190		
t_f	Fall Time		T_J = 25℃		221		ns
			T_J = 125℃		379		
E_{on}	Turn-on Switching Loss		T_J = 25℃		1.86		mJ
			T_J = 125℃		2.45		
E_{off}	Turn-off Switching Loss		T_J = 25℃		0.90		mJ
			T_J = 125℃		1.68		
Q_g	Total Gate Charge		T_J = 25℃		430		nC
RBSOA	Reverse Bias Safe Operation Area	I_C=50A,V_{CC}=960V,Vp=1200V, Rg = 20Ω, V_{GE}=+15V to 0V, T_J =175°C		Trapezoid			
SCSOA	Short Circuit Safe Operation Area	V_{CC} = 600V, V_{GE} = 15V, T_J = 150℃		10			μs
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case				0.499		℃/W

Diode, Brake-Chopper

Maximum Rated Values (T_C=25℃unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	10	A
I_{FM}	Repetitive Peak Forward Current	20	A

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Electrical Characteristics of FWD (T_C=25℃unless otherwise specified)

Symbol	Description	Conditions		Min	Typ	Max	Unit
V_{FM}	Forward Voltage	I_F = 10 A	T_J = 25℃		1.80	2.30	V
			T_J = 125℃		2.00		
I_{rr}	Peak Reverse Recovery Current	I_F=10A, di/dt =500A/μs, V_{rr} = 600V, V_{GE} = -15V	T_J = 25℃		10		A
			T_J = 125℃		15		
Q_{rr}	Reverse Recovery Charge		T_J = 25℃		0.75		μC
			T_J = 125℃		1.50		
E_{rec}	Reverse Recovery Energy		T_J = 25℃		0.30		mJ
			T_J = 125℃		0.62		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case				1.21		℃/W

Diode, Rectifier

Maximum Rated Values (T_C=25℃unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	T_J =25℃	1800	V
I_{FRMSM}	Maximum RMS Forward Current per Chip	T_J =80℃	50	A
I_{RMSM}	Maximum RMS Current at Rectifier Output	T_J =80℃	60	A
I_{FSM}	Surge Current @t_p=10 ms	T_J =25℃	315	A
		T_J =150℃	270	
I^2t	I²t - value	T_J =25℃	500	A^2s
		T_J =150℃	370	

Electrical Characteristics of Diode (T_C=25℃unless otherwise specified)

V_F	Forward Voltage	I_F = 25 A	T_J =25℃	1.05			V
			T_J =150℃	1.00			
I_R	Reverse Current	V_R=1800V	T_J =25℃			1	mA
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case				0.59		℃/W

Internal NTC-Thermistor Characteristics

R_{25}	T_C =25℃	5		kΩ
△R/R	T_C =100℃，R_{100} =481Ω		±5	%
P_{25}	T_C =25℃	50		mW
$B_{25/50}$	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15K))]$	3380		K
$B_{25/80}$	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15K))]$	3440		K

Module

Symbol	Description		Min	Typ	Max	Unit
V_{iso}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500			V
T_J	Maximum Junction Temperature				175	℃
T_{JOP}	Maximum Operating Junction Temperature Range		-40		+150	℃
T_{stg}	Storage Temperature		-40		+125	℃
CTI	Comparative Tracking Index		200			V
$R_{\theta CS}$	Case-To-Sink Thermally (Conductive Grease Applied)			0.05		℃/W
T	Mounting Screw:M4		1.0		1.5	N·m
G	Weight			31		g

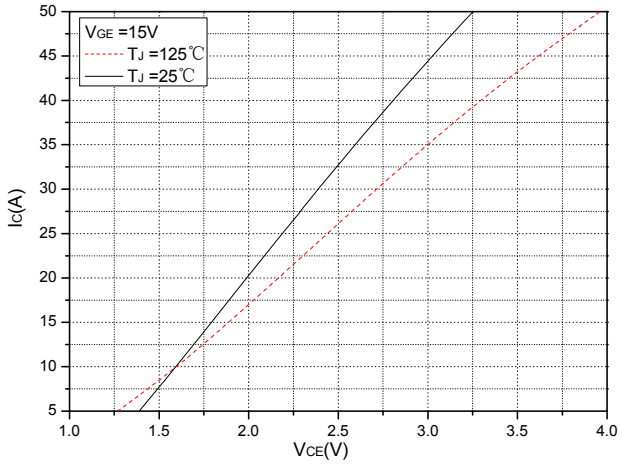


Fig.1 Typical Saturation Voltage Characteristics (Inverter)

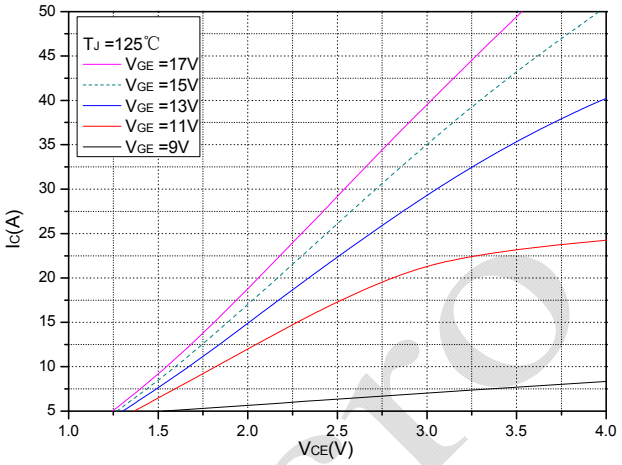


Fig.2 Typical Output Characteristics (Inverter)

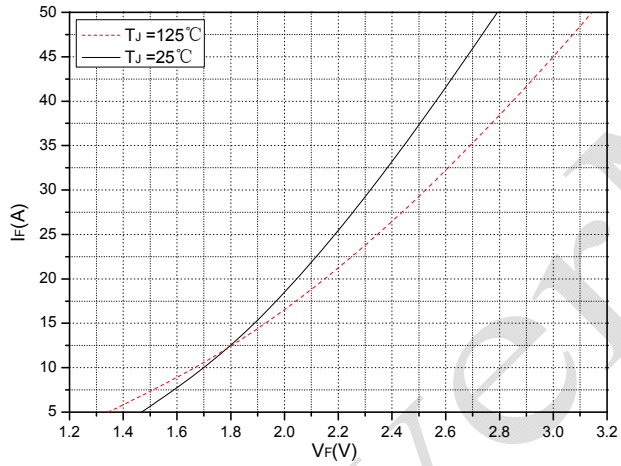


Fig.3 Forward Characteristics of FWD (Inverter)

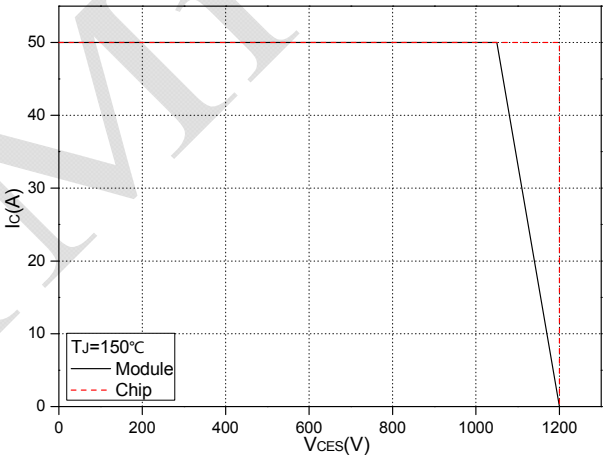


Fig.4 Reverse Bias Safe Operation Area (RBSOA)

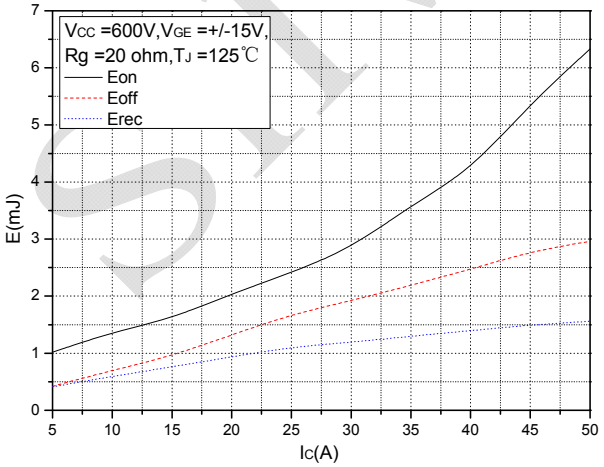


Fig.5 Typical Switching Loss vs. Collector Current

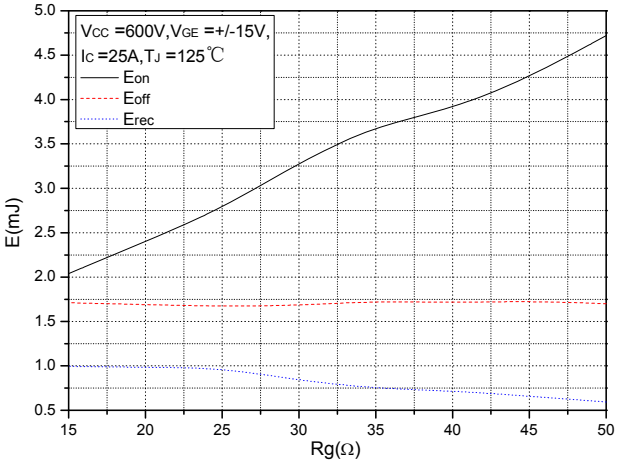


Fig.6 Typical Switching Loss vs. Gate Resistance

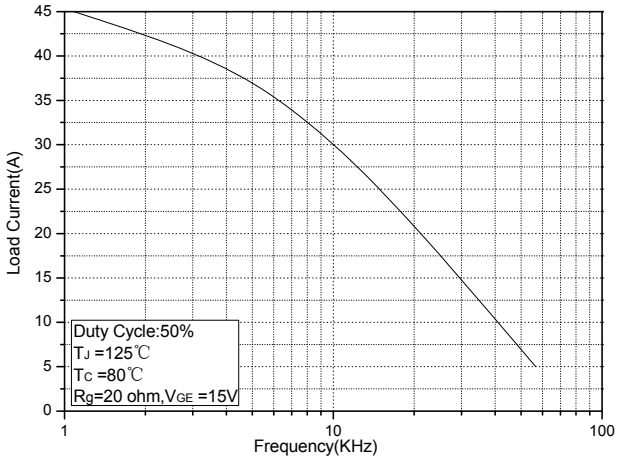


Fig.7 Typical Load Current vs. Frequency

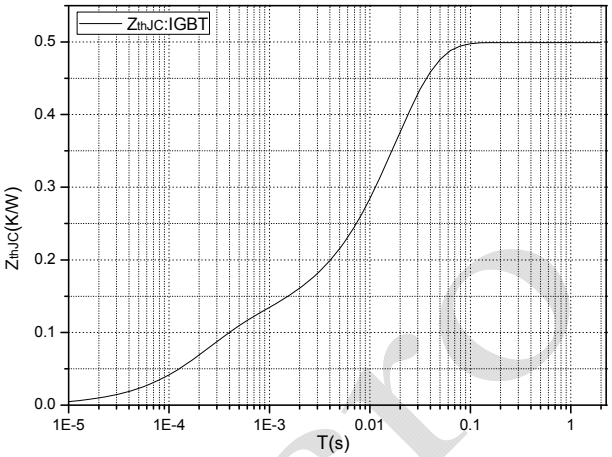


Fig.8 Transient Thermal Impedance (IGBT)

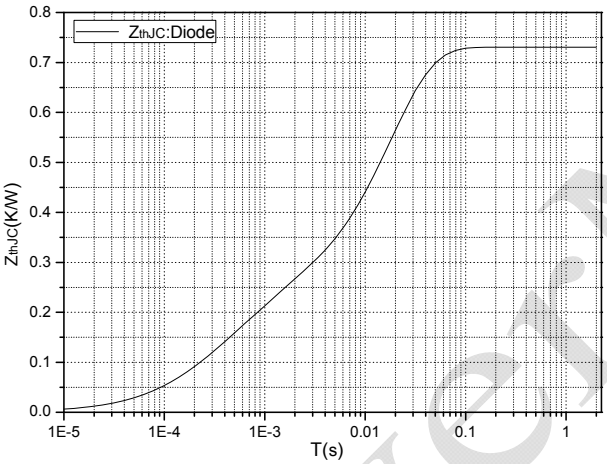


Fig.9 Transient Thermal Impedance (Diode)

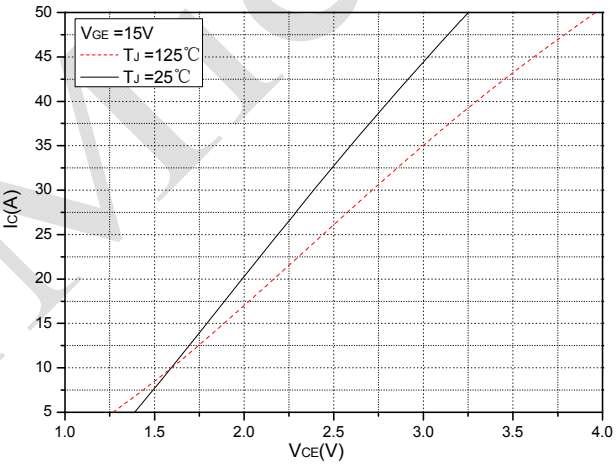


Fig.10 Typical Saturation Voltage Characteristics (Brake-Chopper)

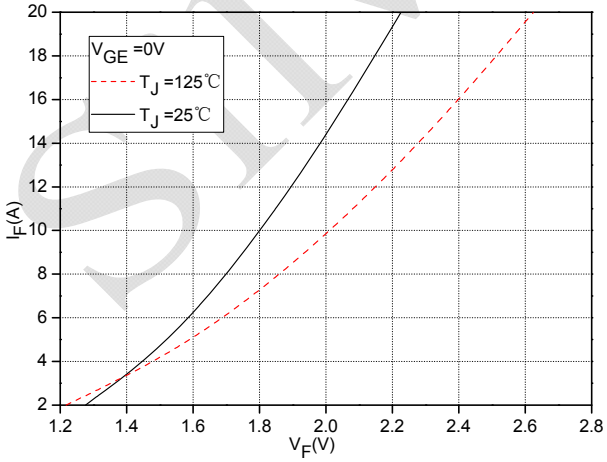


Fig.11 Forward Characteristics of Diode (Brake-Chopper)

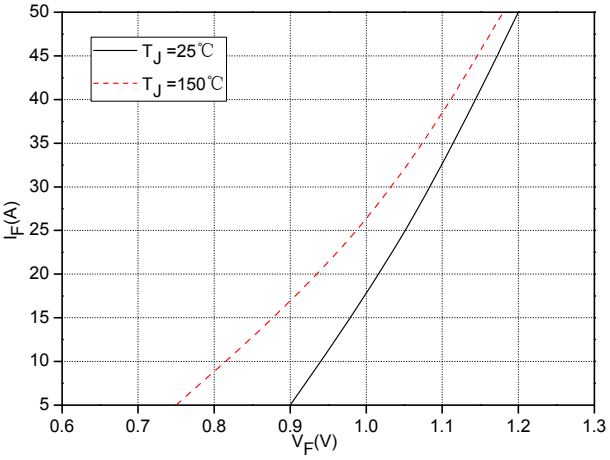


Fig.12 Forward Characteristics of Diode (Rectifier)

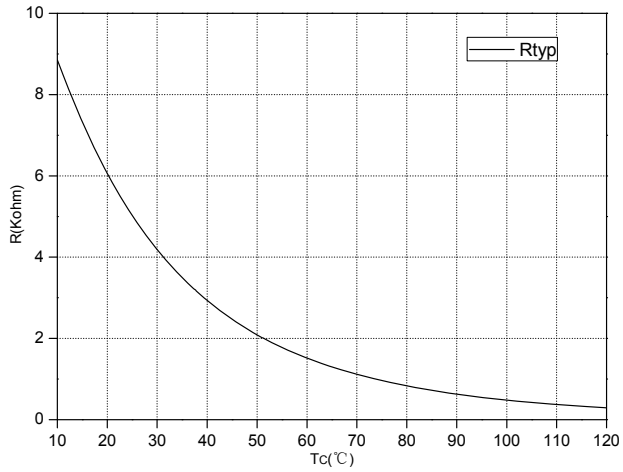
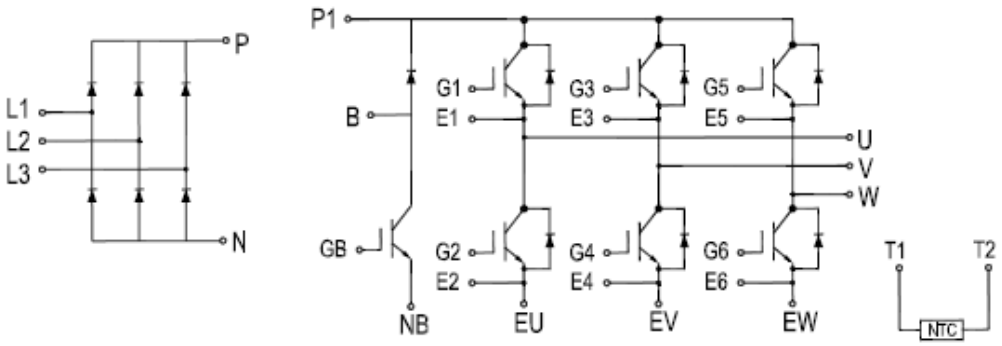
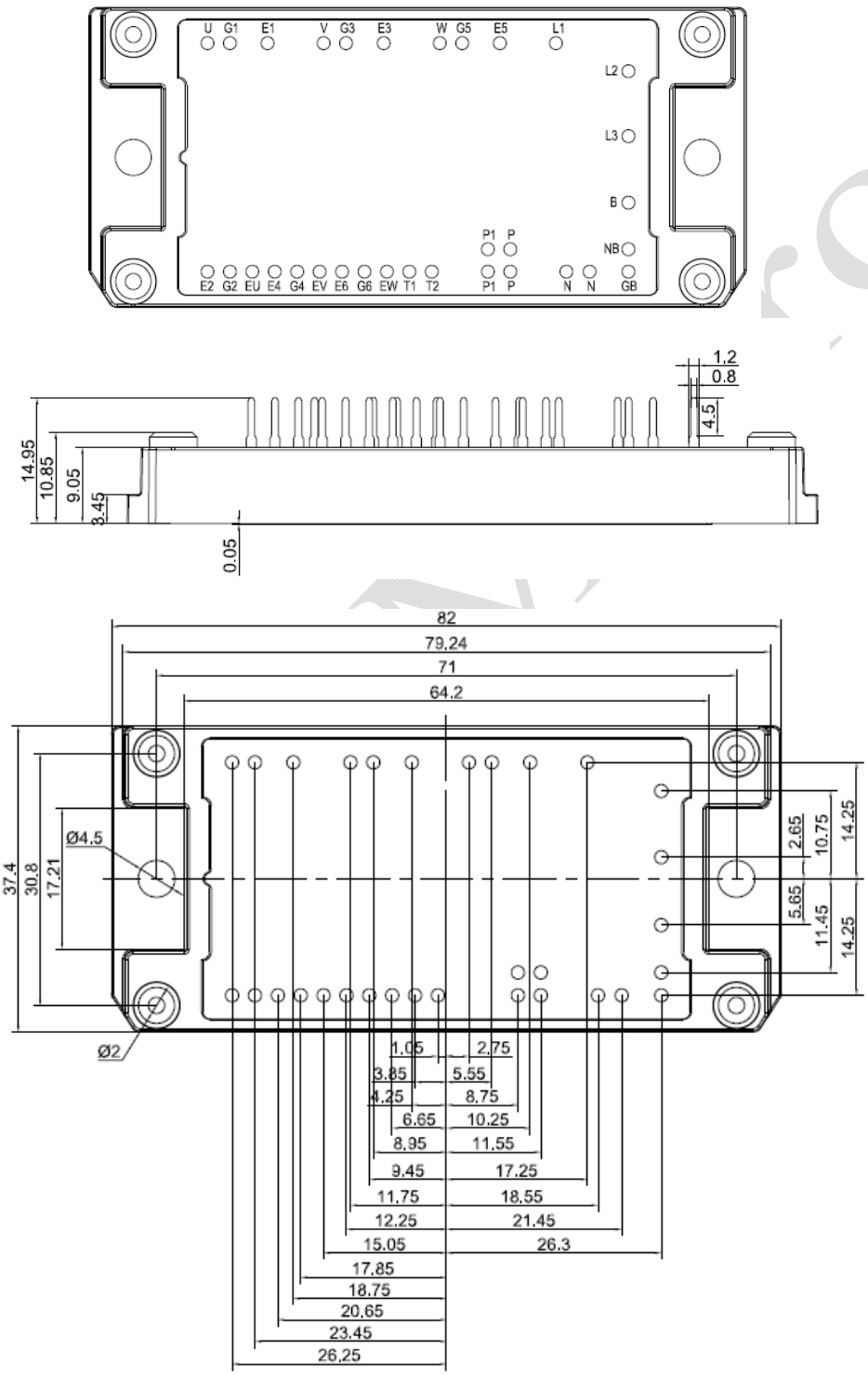


Fig.13 NTC Temperature Characteristics

Internal Circuit:



Package Outline (Unit: mm):



Date	Revision	Notes
05/28/2018	01	Initial release

Announcement

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